MOSFET – Power, N-Channel, SUPERFET[®] III, FRFET[®]

650 V, 65 A, 40 m Ω

NTHLD040N65S3HF

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

Features

- 700 V @ $T_J = 150^{\circ}C$
- Typ. $R_{DS(on)} = 32 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 159 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 1367 pF)
- 100% Avalanche Tested
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

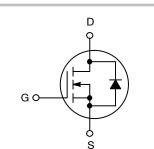
- Telecom / Server Power Supplies
- Industrial Power Supplies
- EV Charger
- UPS / Solar

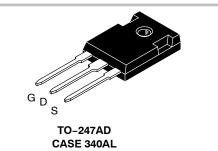


ON Semiconductor®

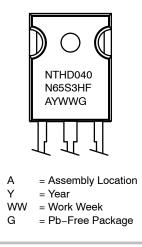
www.onsemi.com

V _{DSS}	R _{DS(ON)} MAX	I _D MAX
650 V	40 m Ω @ 10 V	65 A





MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	Value	Unit			
V _{DSS}	Drain to Source Voltage		650	V		
V _{GSS}	Gate to Source Voltage	– DC	±30	V		
		– AC (f > 1 Hz)	±30			
ID	Drain Current	– Continuous (T _C = 25°C)	65	А		
		– Continuous (T _C = 100°C)	45	1		
I _{DM}	Drain Current - Pulsed (Note 1)	M Drain Current - Pulsed (Note 1)	– Pulsed (Note 1)	- Pulsed (Note 1)	162.5	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		1009	mJ		
I _{AS}	Avalanche Current (Note 2)		9	А		
E _{AR}	Repetitive Avalanche Energy (Note 1)		4.46	mJ		
dv/dt	MOSFET dv/dt		100	V/ns		
	Peak Diode Recovery dv/dt (Note 3)		50			
PD	Power Dissipation	(T _C = 25°C)	446	W		
		- Derate Above 25°C	3.57	W/°C		
T _J , T _{STG}	Operating and Storage Temperature Range		–55 to +150	°C		
TL	Maximum Lead Temperature for Soldering, 1/8"	from Case for 5 seconds	300	°C		

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 9 \text{ A}, R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \leq 32.5 \text{ A}, \text{ di/dt} \leq 200 \text{ A/}\mu\text{s}, V_{DD} \leq 400 \text{ V}, \text{ starting } T_J = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.28	°C/W
R _{0JA}	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NTHLD040N65S3HF	NTHLD040N65S3HF	TO-247	Tube	N/A	N/A	30 Units

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
FF CHARACT	ERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	650			V
		V_{GS} = 0 V, I _D = 1 mA, T _J = 150°C	700			V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 15 \text{ mA}$, Referenced to 25°C		0.63		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$			10	μA
		$V_{DS} = 520 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$		213		
I _{GSS}	Gate to Body Leakage Current	V_{GS} = ±30 V, V_{DS} = 0 V			±100	nA

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 2.1 \text{ mA}$	3.0		5.0	V
R _{DS(on)}	Static Drain to Source On Resistance	V_{GS} = 10 V, I _D = 32.5 A		32	40	mΩ
9fs	Forward Transconductance	V_{DS} = 20 V, I _D = 32.5 A		48		S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 400 V, V_{GS} = 0 V, f = 1 MHz	5945	pF
C _{oss}	Output Capacitance		135	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	1367	pF
C _{oss(er.)}	Energy Related Output Capacitance	$V_{DS} = 0$ V to 400 V, $V_{GS} = 0$ V	245	pF
Q _{g(tot)}	Total Gate Charge at 10V	$V_{DS} = 400 \text{ V}, \text{ I}_{D} = 32.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	159	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	46	nC
Q _{gd}	Gate to Drain "Miller" Charge	1	64	nC
ESR	Equivalent Series Resistance	f = 1 MHz	1.2	Ω

SWITCHING CHARACTERISTICS

t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 32.5 \text{ A},$	40	ns
t _r	Turn-On Rise Time	V _{GS} = 10 V, R _g = 2.2 Ω (Note 4)	32	ns
t _{d(off)}	Turn-Off Delay Time		102	ns
t _f	Turn-Off Fall Time		26	ns

SOURCE-DRAIN DIODE CHARACTERISTICS

۱ _S	Maximum Continuous Source to Drain Diode Forward Current			65	А
I _{SM}	Maximum Pulsed Source to Drain Diode Forward Current			162.5	А
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 32.5 A		1.3	V
t _{rr}	Reverse Recovery Time	$V_{DD} = 400 \text{ V}, \text{I}_{SD} = 32.5 \text{ A},$	160		ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 100 \text{ A}/\mu \text{s}$	874		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

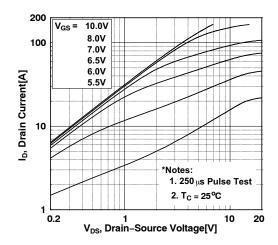


Figure 1. On–Region Characteristics

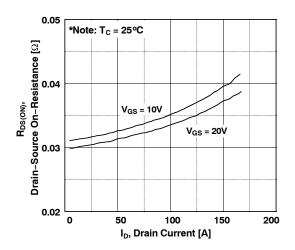


Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage

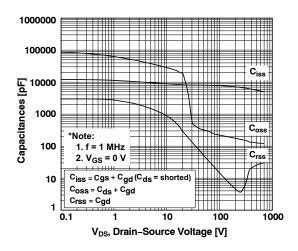


Figure 5. Capacitance Characteristics

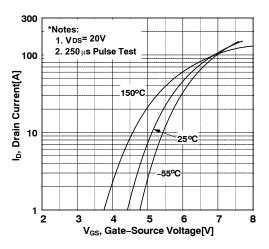


Figure 2. Transfer Characteristics

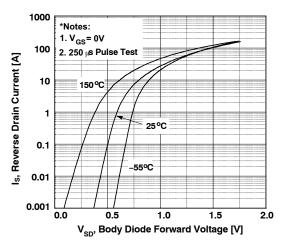


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

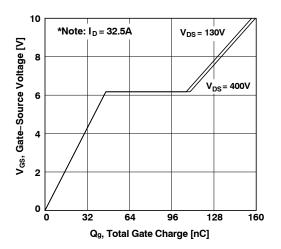
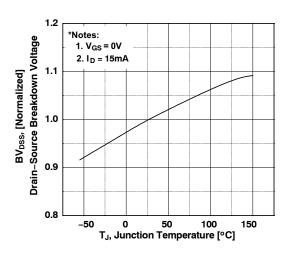
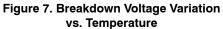


Figure 6. Gate Charge Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





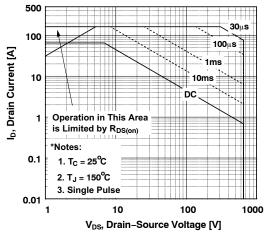


Figure 9. Maximum Safe Operating Area

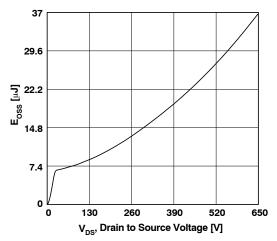


Figure 11. Eoss vs. Drain to Source Voltage

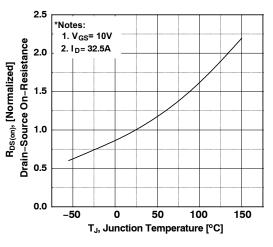


Figure 8. On–Resistance Variation vs. Temperature

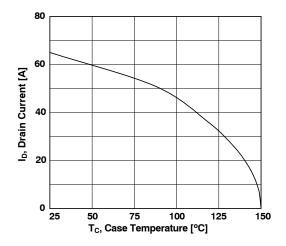


Figure 10. Maximum Drain Current vs. Case Temperature

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

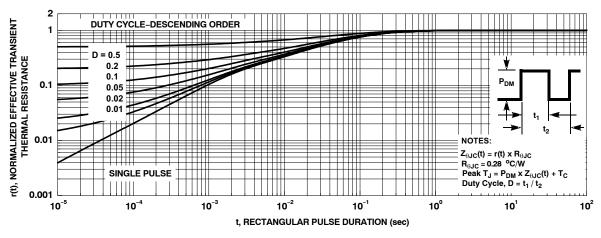
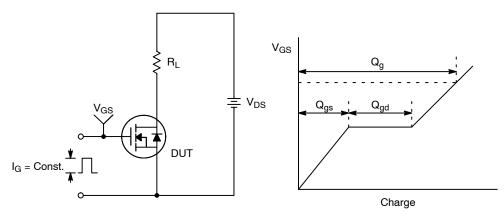


Figure 12. Transient Thermal Response Curve





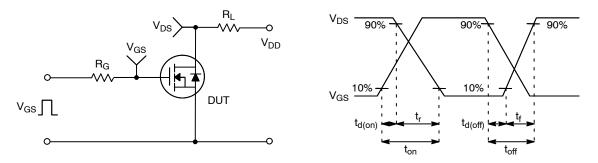


Figure 14. Resistive Switching Test Circuit & Waveforms

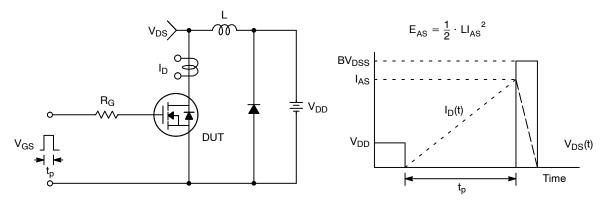


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

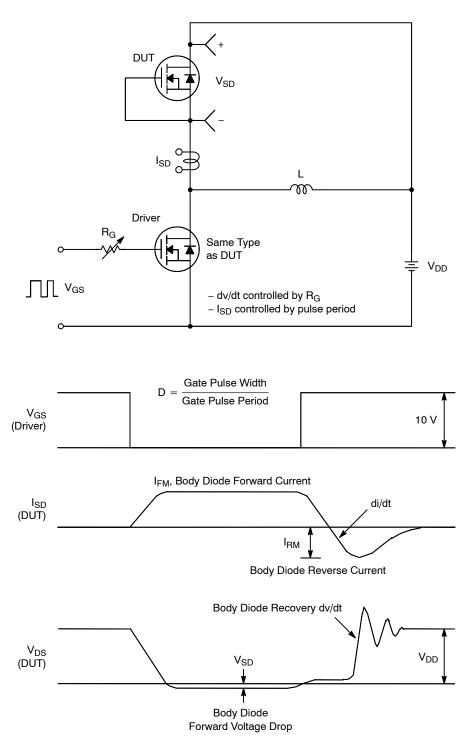


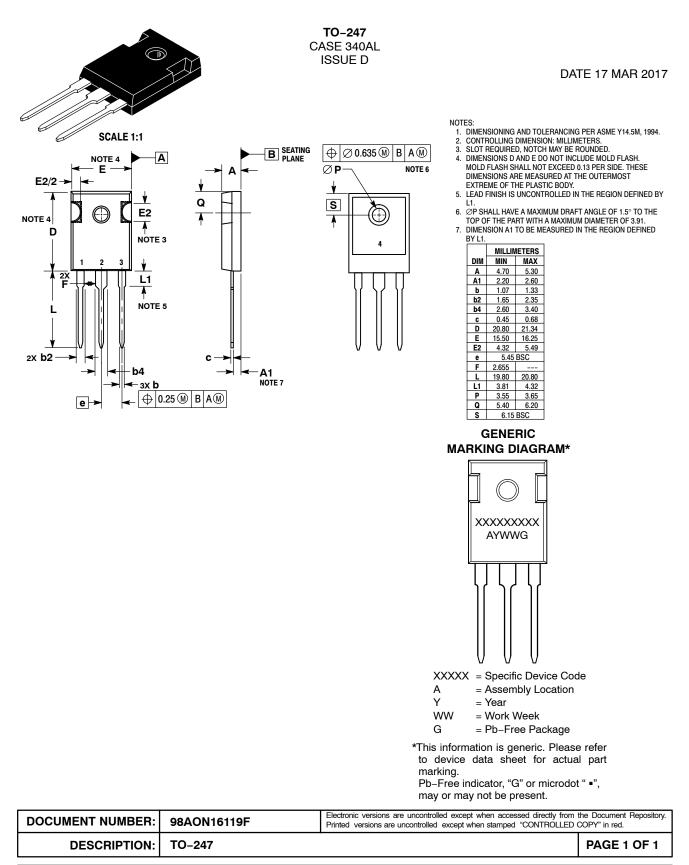
Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

SUPERFET and FRFET are registered trademarks of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS





ON Semiconductor and (III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor date sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use a a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor houteds for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

ON Semiconductor Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910 Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative